

LM4041 1.225V Precision micropower shunt voltage reference

Description

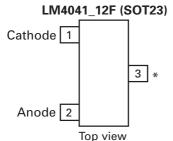
The LM4041 is a bandgap circuit designed to achieve a precision micro-power voltage reference of 1.225 V. The device is available in the small outline SOT23 surface mount packages which is ideal for applications where space saving is important.

The LM4041 is available to 0.5% C grade for precision applications. Excellent performance is maintained over the $60\mu A$ to 12mAoperating current range with a typical temperature coefficient of only 20ppm/°C.

Features

- Small packages: SOT23 •
- No output capacitor required
- Output voltage tolerance
 - LM4041C ±0.5% at 25°C
 - LM4041D +1% at 25°C
- · Low output noise (10 Hz to 10kHz) 60μ Vrms
- Wide operating current range 60μA to 12mA
- Extended temperature range -40°C to +125°C
- Low temperature coefficient 100ppm/°C (max)

Pinout information



* Pin 3 must be left floating or connected to pin 2

Ordering information

25°C tol.	Voltage (V)	Order code	Pack	Part mark	Status	Reel size	Tape width	Quantlty per reel
0.5%	1.225	LM4041CFTA	SOT23	R1C	Preview	7", 180mm	8mm	3000
1%	1.225	LM4041DFTA	SOT23	R1D	Preview	7", 180mm	8mm	3000

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The device has been designed to be highly tolerant of capacitive loads so maintaining excellent stability.

This device offers a pin for pin compatible alternative to the LM4041 voltage reference.

Applications

- Battery powered equipment
- Precision power supplies
- Portable instrumentation
- Portable communications devices
- Notebook and palmtop computers
- Data acquisition systems

Absolute maximum ratings

Continuous reverse current (I_{KA}) 20mA

Continuous forward current (I_{REF}) 10mA

Operating junction temperature -40°C to 150°C

Storage temperature -55°C to 150°C

Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

Unless otherwise stated voltages specified are relative to the ANODE pin.

Package thermal data

Package	Θ_{JA}	P _{DIS} T _{amb} =25°C, T _J = 150°C
SOT23	380°C/W	330mW

Recommended operating conditions

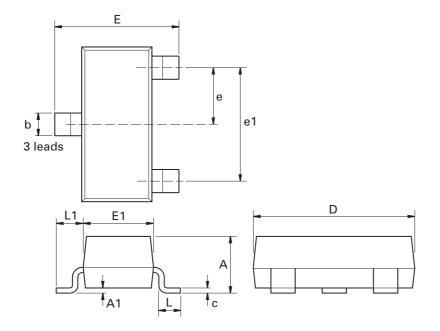
	Min.	Max.	Units
Reverse current	0.06	15	mA
Operating ambient temperature range	-40	125	°C

Electrical characteristics

Over recommended operating conditions, $T_{amb} = 25$ °C, unless otherwise stated. LM4041C and LM4041D have initial tolerances of 0.5% and 1% respectively.

Symbol	Parameter	Conc	Тур.	LM4041C		Units		
			T _{amb}		Limits	Limits		
	Reverse breakdown voltage	I _R = 100 μA	25°C	1.225			V	
V _{REF}	Reverse breakdown voltage tolerance		25°C		±6	±12		
		I _R = 100μA	-40 to 85°C		±14	±24	mV	
			-40 to 125°C		±18.4	±31		
			25°C		60	65	μA	
I _{RMIN}	Minimum operating current		-40 to 85°C	45	65	70		
			-40 to 125°C		68	73		
$\Delta V_{R} / \Delta T$	Average reverse	l _R = 10 mA	-40 to 125°C	±20				
	breakdown voltage	l _R = 1 mA,		±15	±100	±150	ppm/°C	
	temperature coefficient	I _R = 100 μA		±15				
	Reverse breakdown change with current	I _{RMIN} < I _R < 1mA	25°C	0.7	1.5	2.0	mV	
			-40 to 85°C		2.0	2.5		
$\Delta V_{R} / \Delta I_{R}$			-40 to 125°C		2.0	2.5		
		1mA < I _R < 12 mA	25°C		6.0	8.0		
			-40 to 85°C		8.0	10.0		
			-40 to 125°C		8.0	10.0		
Z _R	Dynamic output impedance	I _R = 1mA, f = 120Hz I _{AC} = 0.1I _R		0.5	1.5	2.0	Ω	
e _n	Noise voltage	I _R = 100μA 10Hz < f < 10kHz		60			μV_{RMS}	
ΔV_{R}	Long term stability (non cumulative)	t = 1000Hrs I _R = 100μA		120			ppm	

Package outline - SOT23



Dim.	Millin	neters	Inc	hes	Dim. Millimeters		neters	Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Max.	Max.
А	-	1.12	-	0.044	e1	1.90	NOM	0.075	NOM
A1	0.01	0.10	0.0004	0.004	E	2.10	2.64	0.083	0.104
b	0.30	0.50	0.012	0.020	E1	1.20	1.40	0.047	0.055
С	0.085	0.120	0.003	0.008	L	0.25	0.62	0.018	0.024
D	2.80	3.04	0.110	0.120	L1	0.45	0.62	0.018	0.024
е	0.95	NOM	0.0375	NOM	-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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